

<u>DB Name</u>	<u>Query</u>	<u>Hit Count</u>	<u>Set Name</u>
USPT,JPAB,EPAB,TDBD	(l21 not l22) and (nickel same thickness)	120	<u>L25</u>
USPT,JPAB,EPAB,TDBD	(l21 not l22) and thickness	240	<u>L24</u>
USPT,JPAB,EPAB,TDBD	l20 or l22	352	<u>L23</u>
USPT,JPAB,EPAB,TDBD	l21 and l1	12	<u>L22</u>
USPT,JPAB,EPAB,TDBD	l19 not l20	280	<u>L21</u>
USPT,JPAB,EPAB,TDBD	l16 or l17	340	<u>L20</u>
USPT,JPAB,EPAB,TDBD	(nickel same diffusion) and seal and (cover or lid)	297	<u>L19</u>
USPT,JPAB,EPAB,TDBD	nickel and diffusion and seal and (cover or lid)	1510	<u>L18</u>
USPT,JPAB,EPAB,TDBD	l15 not l16	71	<u>L17</u>
USPT,JPAB,EPAB,TDBD	l9 or l8 or l11	269	<u>L16</u>
USPT,JPAB,EPAB,TDBD	lid and nickel and (package same "electronic component")	106	<u>L15</u>
USPT,JPAB,EPAB,TDBD	4737418[uref]	6	<u>L14</u>
USPT,JPAB,EPAB,TDBD	4737418.pn.	2	<u>L13</u>
USPT,JPAB,EPAB,TDBD	l10 not l9	22	<u>L12</u>
USPT,JPAB,EPAB,TDBD	l10 not l9	22	<u>L11</u>
USPT,JPAB,EPAB,TDBD	l7 and l1	109	<u>L10</u>
USPT,JPAB,EPAB,TDBD	l4 or l5 or l3	247	<u>L9</u>
USPT,JPAB,EPAB,TDBD	l4 or l5	167	<u>L8</u>
USPT,JPAB,EPAB,TDBD	(lid same (seal or sealing)) and nickel and cover	732	<u>L7</u>
USPT,JPAB,EPAB,TDBD	(lid same (seal or sealing)) and nickel	1278	<u>L6</u>
USPT,JPAB,EPAB,TDBD	l4 not l3	93	<u>L5</u>
USPT,JPAB,EPAB,TDBD	l2 and (seal or sealing) and (braze or brazing)	167	<u>L4</u>
USPT,JPAB,EPAB,TDBD	l2 and l1	154	<u>L3</u>
USPT,JPAB,EPAB,TDBD	(hermetic or hermeticity) and (lid or "sealing cover" or "cover plate" or coverplate) and nickel	629	<u>L2</u>
USPT	((174/52.1 174/50.5 174/52.3 174/52.4)!.CCLS. (257/704)!.CCLS. (427/58)!.CCLS. (428/621 428/34.1 428/615 428/680 428/681 428/679 428/600 428/940 428/673)!.CCLS. (228/124.6)!.CCLS. (220/200)!.CCLS. (438/121 438/125 438/126)!.CCLS. (or/)!.CCLS.)	9602	<u>L1</u>